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## 30 A, 600 V, Ultrafast Diode

### Description

The RURG3060 is an ultrafast diode with low forward voltage drop. This device is intended for use as freewheeling and clamping diodes in a variety of switching power supplies and other power switching applications. It is specially suited for use in switching power supplies and industrial application.

### Ordering Information

PART NUMBER	PACKAGE	BRAND
RURG3060	TO-247-2L	RURG3060

NOTE: When ordering, use the entire part number.

### Symbol



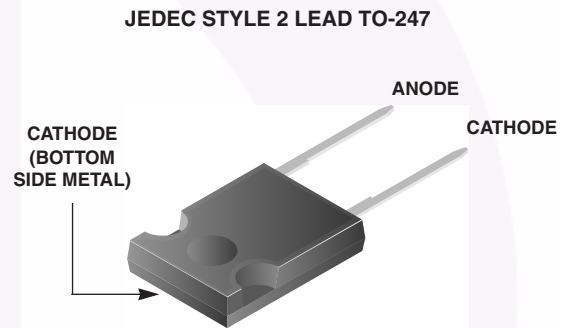
### Features

- Ultrafast Recovery  $t_{rr} = 60$  ns (@  $I_F = 30$  A)
- Max Forward Voltage,  $V_F = 1.5$  V (@  $T_C = 25^\circ\text{C}$ )
- 600 V Reverse Voltage and High Reliability
- Avalanche Energy Rated
- RoHS Compliant

### Applications

- Switching Power Supplies
- Power Switching Circuits
- General Purpose

### Packaging



### Absolute Maximum Ratings $T_C = 25^\circ\text{C}$ , Unless Otherwise Specified

	RURG3060	UNIT
Peak Repetitive Reverse Voltage .....	$V_{RRM}$ 600	V
Working Peak Reverse Voltage .....	$V_{RWM}$ 600	V
DC Blocking Voltage .....	$V_R$ 600	V
Average Rectified Forward Current .....	$I_{F(AV)}$ 30	A
( $T_C = 130^\circ\text{C}$ )		
Repetitive Peak Surge Current .....	$I_{FRM}$ 70	A
(Square Wave, 20 kHz)		
Nonrepetitive Peak Surge Current .....	$I_{FSM}$ 325	A
(Halfwave, 1 Phase, 60 Hz)		
Maximum Power Dissipation .....	$P_D$ 125	W
Avalanche Energy (See Figures 7 and 8) .....	$E_{AVL}$ 20	mJ
Operating and Storage Temperature .....	$T_{STG}, T_J$ -65 to 175	$^\circ\text{C}$

**Electrical Specifications**  $T_C = 25^\circ\text{C}$ , Unless Otherwise Specified

SYMBOL	TEST CONDITION	TYP	MAX	UNIT
$V_F$	$I_F = 30\text{ A}$	-	1.5	V
	$I_F = 30\text{ A}, T_C = 150^\circ\text{C}$	-	1.3	V
$I_R$	$V_R = 600\text{ V}$	-	250	$\mu\text{A}$
	$V_R = 600\text{ V}, T_C = 150^\circ\text{C}$	-	1	mA
$t_{rr}$	$I_F = 1\text{ A}, dI_F/dt = 100\text{ A}/\mu\text{s}$	-	55	ns
	$I_F = 30\text{ A}, dI_F/dt = 100\text{ A}/\mu\text{s}$	-	60	ns
$t_a$	$I_F = 30\text{ A}, dI_F/dt = 100\text{ A}/\mu\text{s}$	30	-	ns
$t_b$	$I_F = 30\text{ A}, dI_F/dt = 100\text{ A}/\mu\text{s}$	20	-	ns
$R_{\theta JC}$		-	1.2	$^\circ\text{C}/\text{W}$

**DEFINITIONS**

$V_F$  = Instantaneous forward voltage ( $p_w = 300\ \mu\text{s}$ ,  $D = 2\%$ ).

$I_R$  = Instantaneous reverse current.

$t_{rr}$  = Reverse recovery time (See Figure 6), summation of  $t_a + t_b$ .

$t_a$  = Time to reach peak reverse current (See Figure 6).

$t_b$  = Time from peak  $I_{RM}$  to projected zero crossing of  $I_{RM}$  based on a straight line from peak  $I_{RM}$  through 25% of  $I_{RM}$  (See Figure 6).

$R_{\theta JC}$  = Thermal resistance junction to case.

$p_w$  = Pulse width.

$D$  = Duty cycle.

**Typical Performance Curves**

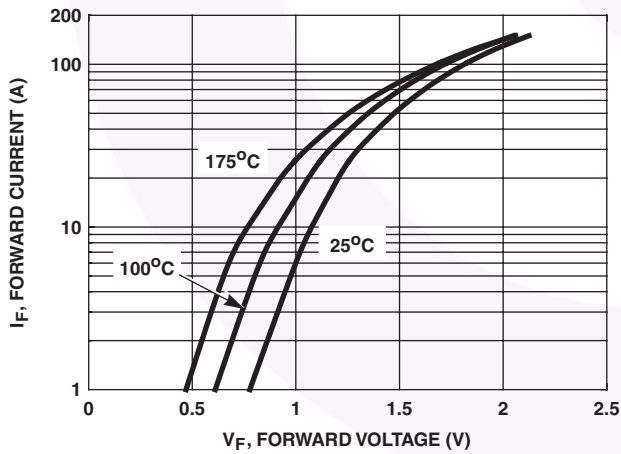


FIGURE 1. FORWARD CURRENT vs FORWARD VOLTAGE

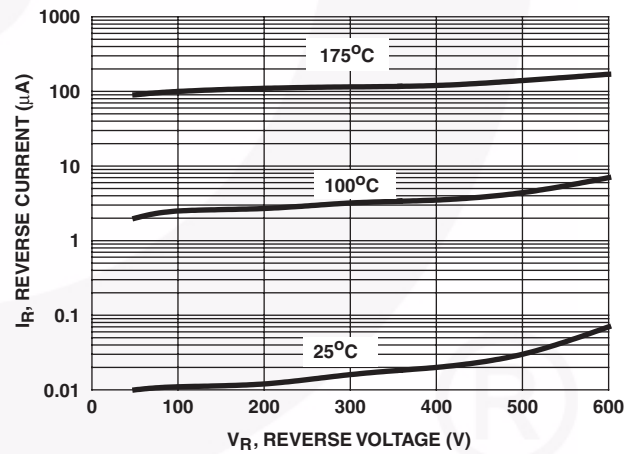


FIGURE 2. REVERSE CURRENT vs REVERSE VOLTAGE

Typical Performance Curves (Continued)

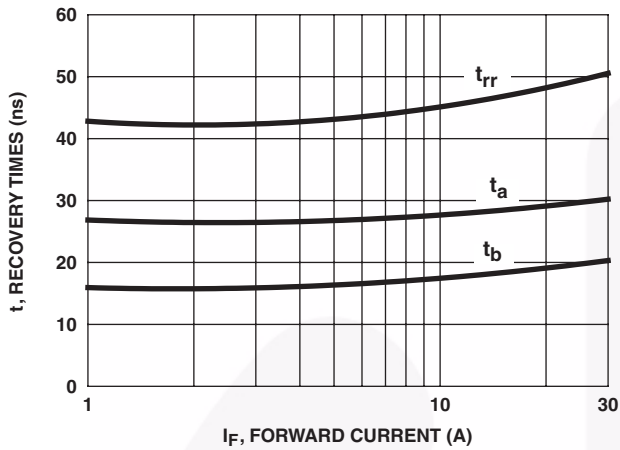


FIGURE 3. t<sub>rr</sub>, t<sub>a</sub> AND t<sub>b</sub> CURVES vs FORWARD CURRENT

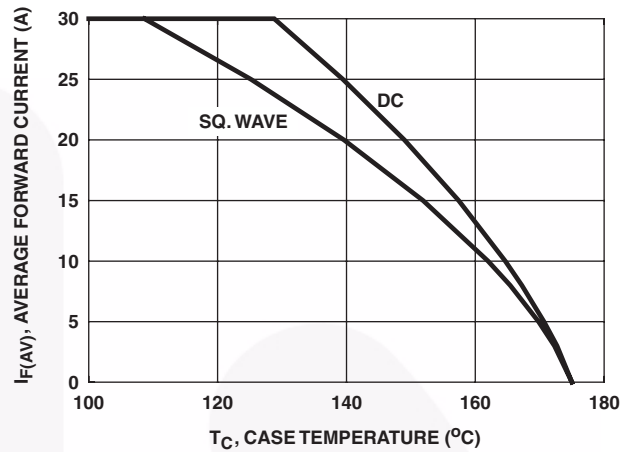


FIGURE 4. CURRENT DERATING CURVE

Test Circuits and Waveforms

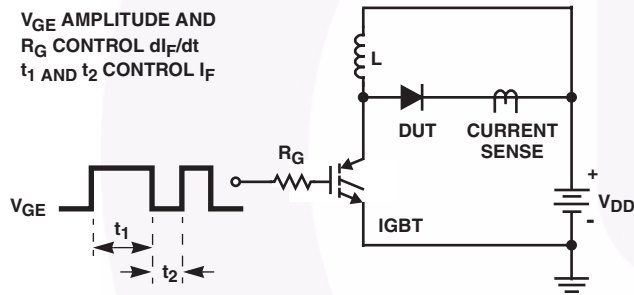


FIGURE 5. t<sub>rr</sub> TEST CIRCUIT

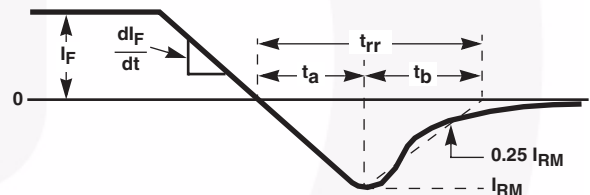


FIGURE 6. t<sub>rr</sub> WAVEFORMS AND DEFINITIONS

I = 1A  
 L = 40mH  
 R < 0.1Ω  
 $E_{AVL} = 1/2LI^2 [V_{R(AVL)}/(V_{R(AVL)} - V_{DD})]$   
 Q<sub>1</sub> = IGBT (BV<sub>CES</sub> > DUT V<sub>R(AVL)</sub>)

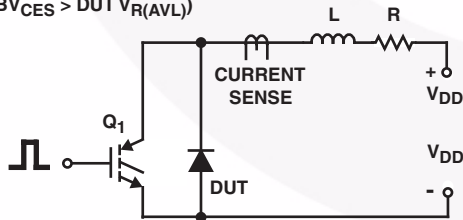


FIGURE 7. AVALANCHE ENERGY TEST CIRCUIT

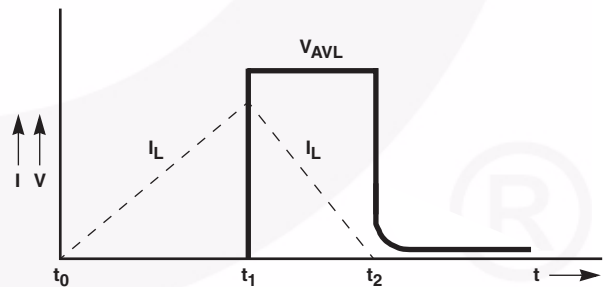


FIGURE 8. AVALANCHE CURRENT AND VOLTAGE WAVEFORMS

## Mechanical Dimensions

## TO247-2L

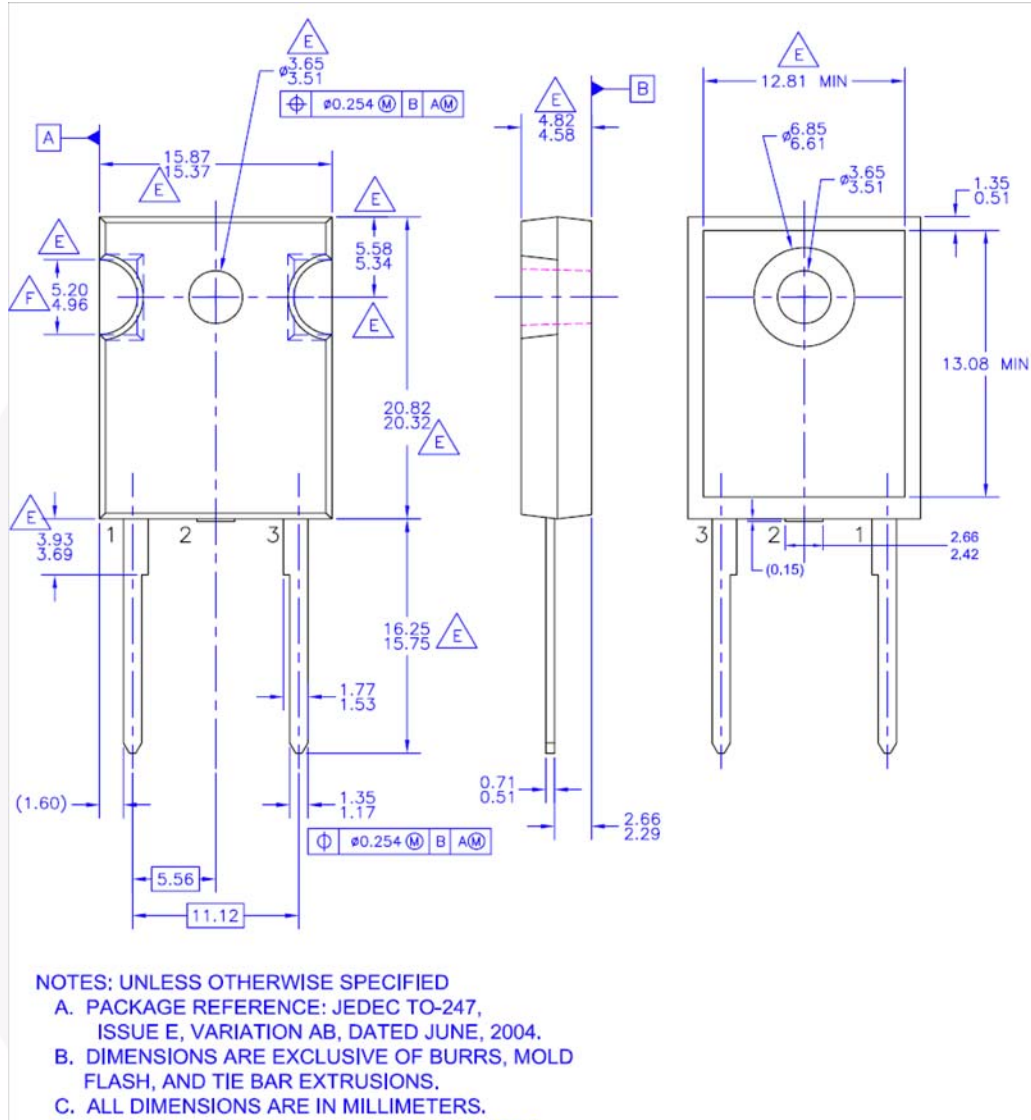


Figure 9. TO-247, Molded, 2LD, Jedec Option AB

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| Build it Now™   | GreenBridge™                                    | QFET®                                 | TinyBuck®   |
| CorePLUS™   | Green FPS™                                      | QS™                                   | TinyCalc™   |
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